



# Call for Papers

## The 2nd IEEE International Conference on Telecommunications and Photonics (ICTP) 2017

December 26-28, 2017

Dept. of EEE, Bangladesh University of Engineering and Technology (BUET)

Dhaka, Bangladesh

Website: [www.ictp-comsoc.org](http://www.ictp-comsoc.org), Email: [info@ictp-comsoc.org](mailto:info@ictp-comsoc.org)

The IEEE International Conference on Telecommunications and Photonics (ICTP) is the second specialized conference on Communication Engineering and Photonics in Bangladesh which will be organized by IEEE ComSoc Bangladesh Chapter. ICTP will bring together individuals from academia, research organizations and industry of worldwide to discuss and share ideas, and to present their latest findings and experiences in the areas of Telecommunication Engineering and Photonics. Prospective authors are invited to submit original technical papers for presentation at the conference. The presented papers will be available in the IEEE Xplore.

### Scope of the Conference

- Ad-hoc and Sensor Networks
- Biomedical Signal Processing
- Big Data
- Cognitive Radio and Software Defined Radio
- Computer Networks
- D2D Communications
- Green Communications
- Internet and Web Applications
- Internet of Things
- Mobile Communications (4G/5G)
- Multimedia Communications
- Multimedia Systems and Applications
- Microwave and Radar Engineering
- Millimeter Wave Communication
- Next Generation Wireless Networks

- Optical Communications
- Optical Networks
- RF and Wireless Communication Systems
- RFID Technology and Applications
- Smart-Grid Communication
- Satellite and Space Communication
- Terahertz Communication
- Vehicular Networks
- Wireless Robotics
- Wireless Emergency and Security Systems
- Biophotonics
- Displays and Lighting
- Guided Wave Photonics
- Graphene Photonics
- Microwave Photonics

- Nonlinear and Ultrafast Optics
- Nano-Photonics
- Optical Interconnects
- Optical Waveguides
- Optical Energy Harvesting
- Optical micro/nano Resonators and Devices
- Optical Sensors
- Photonic Integration and Packaging
- Photonic Materials and Metamaterials
- Photonic Crystal Devices
- Photodetectors
- Sensors, Systems and Imaging
- Plasmonics
- Silicon Photonics
- Solid State and Semiconductor Lasers

### Important Dates

Paper Submission: Aug. 31, 2017

Notification of Acceptance: Oct. 30, 2017

Camera Ready Submission: Nov. 15, 2017

Registration: Dec. 01, 2017

### Call for Tutorials:

Submission of Proposals: Oct. 15, 2017

### Registration

Local Author (Non-IEEE Member): 6000 BDT

Local Author (IEEE Member): 5000 BDT

International Author (Non-IEEE Mem): 300 USD

International Author (IEEE Member): 250 USD

SAARC Author (Non-IEEE Member): 200 USD

SAARC Author (IEEE Member): 150 USD

Local Student Author (Non-IEEE Member): 4000 BDT

Local Student Author (IEEE Member): 3000 BDT

Int. Student Author: 150 USD

Participant: 6000 BDT

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